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TRANSMITTAL FORM (to be used for all correspondence after initial filing)		Filing Date		December 2, 1999
		First Named	Inventor	Eikatsu Yamaguchi
		Group Art Un	it	1733
		Examiner Na	Examiner Name J. Aftergut	
Total Number of Pages in This Submission 12		Attorney Docket Number		032405W027
	ENCLO	SURES (check	all that apply)	
Fee Transmittal Form	Form Assignr			After Allowance Communication to Group
Fee Attached Drawin				Appeal Communication to Board of Appeals and Interferences
Amendment / Response		ng-related Paper	s	Appeal Communication to Group (Appeal Notice, Brief, Reply Brief)
After Final	Petition	l		Proprietary Information
Affidavits/declaration(s)		to Convert to a onal Application		Status Letter
Extension of Time Request	ower of Attorney, Revocation nange of Correspondence Address		Other Enclosure(s) (please identify below):	
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Firm or Robert G. Weilacher				°n.
Signature	MA	July		COPY OF PAPERS
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ocket No. 032405W027

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants:

EIKATSU YAMAGUCHI, et al.

Serial No.:

09/453,055

December 2, 1999

Examiner:

Art Unit:

Filed:

For:

METHOD OF FORMING HONEYCOMB SANDWICH

COMPOSITE PANELS

AMENDMENT

Assistant Commissioner for Patents Washington, D.C. 20231

Sir:

In response to the Office Action dated May 24, 2002, please amend the above-identified

patent application as follows:

IN THE CLAIMS:

Kindly delete Claims 1, 3-6 and 11-13, without prejudice.

Please amend Claim 2 as follows:

(Twice Amended) A method of forming a honeycomb sandwich composite panel

consisting essentially of:

stacking a thermosetting sealing material on at least one side of a honeycomb core, said thermosetting sealing material having an adhesive property and being a resin film

including glass microspheres;

stacking a dry fabric on said thermosetting sealing material;

haldening said sealing material by heating said sealing material and said dry fabric

to the curing temperature of said sealing material and maintaining this temperature for a specified

curing time period of said sealing material;

CERTIFICATE OF MAILING

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TC 1700